ABSOCIATION CONNECTING ELECTRONCE INDUSTRIES® INDUSTRIES® INDUSTRIES®	ockburn, Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declara he declaration	tion of the s	substances es all lowe	within the manufactu er level materials for w	rer listed it hich the m	em. Note: if anufacturer	the item is an as has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute			*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials ar					and Mfg Information			
Supplier Information													
Company name* Company unique ID			ID Unic			Unique ID Authority				Response Date*			
onsemi	ai								2024-05-19				
Contact Name	Title - Contact				Phone - Contact*				Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Authorized Representative*	rized Representative* Title - Representative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com					
Requester Item Number Mfr	Item Number	Mfr Item Name			Effective Dat	e Versior	1	Manufacturing Site		Weight*	UOM	Unit Type	
NVI	FSC0D9N04CL 40V T6 LL in 5x6		6 Dual Cool		2024-05-19			РВВ		21.5064	mg	Each	
Manufacturing Proccess Information												·	
Terminal Plating / Grid Array Material	Terminal Base Alloy		J-STD-020 MSL	Rating	Peak Pro	ocess Body Temperature Max Time at Peak		Temperati	ure Numbe	er of Reflow Cyc	cles		
Matte Tin (Sn) - annealed CU Alloy 1			1		260		С	30	second	ds 3			
Comments													
level 1 - maximum time at peak temperature durin	g soldering is 10-3	0 seconds											
For more information regarding material composi	tion please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified information. However, in situations where Supplier has not ndependently verified information provided by others, Supplier agrees that, at a minimum, itsuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of hat agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).							
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	19.1	mg	Supplier	Zinc (Zn)	7440-66-6		0.0229	mg
			Supplier	Iron (Fe)	7439-89-6		0.4489	mg
			Supplier	Copper (Cu)	7440-50-8		18.6225	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0057	mg
Die	2.54	mg	Supplier	Silicon (Si)	7440-21-3		2.54	mg
Die Attach Solder	3.021	mg	Supplier	Silver (Ag)	7440-22-4		0.0755	mg
			А	Lead (Pb)	7439-92-1	7a	2.7944	mg
			Supplier	Tin (Sn)	7440-31-5		0.151	mg
Lead Frame	45.8	mg	Supplier	Silver (Ag)	7440-22-4		0.1374	mg
			Supplier	Zinc (Zn)	7440-66-6		0.055	mg
			Supplier	Iron (Fe)	7439-89-6		1.0763	mg
			Supplier	Copper (Cu)	7440-50-8		44.5176	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0137	mg
Mold Compound-Black	42.715	mg	Supplier	Trimethoxysilylpropanethiol	4420-74-0		0.2136	mg
			Supplier	Boron zinc hydroxide oxide	138265-88-0		6.4073	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		6.4073	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1068	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		27.2308	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.3493	mg
lating	8.33	mg	Supplier	Tin (Sn)	7440-31-5		8.33	mg
Wire Bond	4.0E-4	mg	Supplier	Palladium (Pd)	7440-05-3		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0004	mg